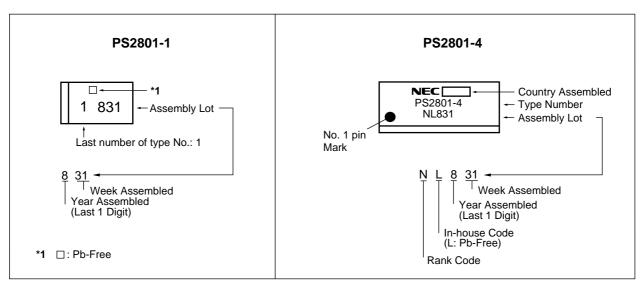
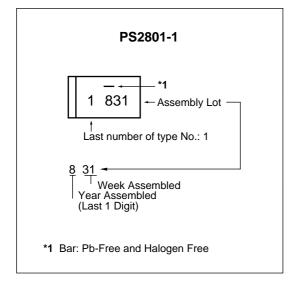


## <R> MARKING EXAMPLE





## Special version (Pb-Free and Halogen Free)



# <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS2801-1	PS2801-1-A	Pb-Free	50 pcs (Tape 50 pcs cut)	Standard products	PS2801-1
PS2801-1-F3	PS2801-1-F3-A		Embossed Tape 3 500 pcs/reel	(UL, BSI, CSA	
PS2801-1-F4	PS2801-1-F4-A			approved)	
PS2801-1-V	PS2801-1-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2801-1-V-F3	PS2801-1-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
PS2801-1-V-F4	PS2801-1-V-F4-A			Approved (Option)	
PS2801-4	PS2801-4-A		Magazine Case 45 pcs	Standard products	PS2801-4
PS2801-4-F3	PS2801-4-F3-A		Embossed Tape 2 500 pcs/reel	(UL, BSI, CSA	
PS2801-4-F4	PS2801-4-F4-A			approved)	
PS2801-4-V	PS2801-4-V-A		Magazine Case 45 pcs	DIN EN60747-5-2	
PS2801-4-V-F3	PS2801-4-V-F3-A		Embossed Tape 2 500 pcs/reel	(VDE0884 Part2)	
PS2801-4-V-F4	PS2801-4-V-F4-A			Approved (Option)	
PS2801-1	PS2801-1Y-A	Special version	50 pcs (Tape 50 pcs cut)	Standard products	PS2801-1
PS2801-1-F3	PS2801-1Y-F3-A	(Pb-Free and	Embossed Tape 3 500 pcs/reel	(UL, BSI, CSA	
		Halogen Free)		approved)	
PS2801-1-V	PS2801-1Y-V-A		50 pcs (Tape 50 pcs cut)	DIN EN60747-5-2	
PS2801-1-V-F3	PS2801-1Y-V-F3-A		Embossed Tape 3 500 pcs/reel	(VDE0884 Part2)	
				Approved (Option)	

\*1 For the application of the Safety Standard, following part number should be used.

Parameter		Symbol	Ratings		Unit
			PS2801-1	PS2801-4	
Diode	Forward Current (DC)	lF	50		mA/ch
	Reverse Voltage	VR	6		V
	Power Dissipation Derating	⊿P <sub>D</sub> /°C	0.6	0.8	mW/°C
	Power Dissipation	PD	60	80	mW/ch
	Peak Forward Current <sup>*1</sup>	IFP	1		A/ch
Transistor	Collector to Emitter Voltage	Vceo	8	0	V
	Emitter to Collector Voltage	Veco	6	3	V
	Collector Current	lc	5	0	mA/ch
	Power Dissipation Derating	⊿Pc/°C	1.	2	mW/°C
	Power Dissipation	Pc	12	20	mW/ch
Isolation Voltage *2		BV	2 500		Vr.m.s.
Operating Ambient Temperature		TA	–55 to +100		°C
Storage Temperature		Tstg	–55 to +150		°C

# ABSOLUTE MAXIMUM RATINGS (Unless otherwise specified, T<sub>A</sub> = 25°C)

\*1 PW = 100 *µ*s, Duty Cycle = 1%

\*2 AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together (PS2801-1). Pins 1-8 shorted together, 9-16 shorted together (PS2801-4).

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 5 mA		1.1	1.4	V
	Reverse Current	Ir	V <sub>R</sub> = 5 V			5	μA
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		15		pF
Transistor	Collector to Emitter Dark Current	Iceo	Vce = 80 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF) <sup>*1</sup>	CTR	IF = 5 mA, Vce = 5 V	80		600	%
	Collector Saturation Voltage	VCE (sat)	l⊧ = 10 mA, lc = 2 mA			0.3	V
	Isolation Resistance	Ri-o	VI-O = 1.0 kVDC	10 <sup>11</sup>			Ω
	Isolation Capacitance	CI-0	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time <sup>*2</sup>	tr	$V_{CC} = 5 \text{ V}, \text{ Ic} = 2 \text{ mA}, \text{ R}_{L} = 100 \Omega$		3		μS
	Fall Time *2	tr			5		

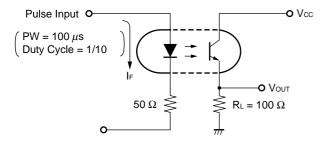
# ELECTRICAL CHARACTERISTICS (TA = 25°C)

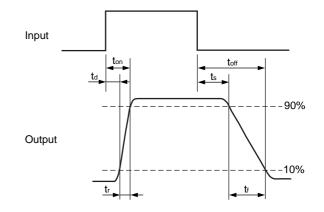
\*1 CTR rank (PS2801-1 only)

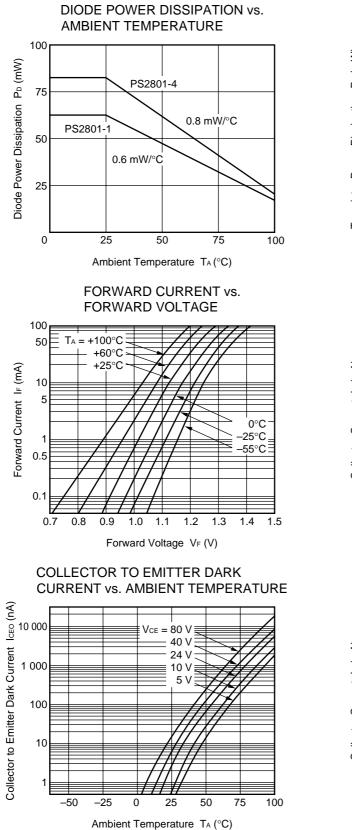
K : 300 to 600 (%) P : 150 to 300 (%) L : 100 to 300 (%) N : 80 to 600 (%)

<R>

\*2 Test circuit for switching time



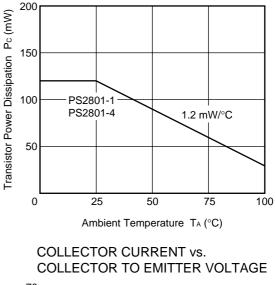




## TYPICAL CHARACTERISTICS (Unless otherwise specified, $T_A = 25^{\circ}C$ )

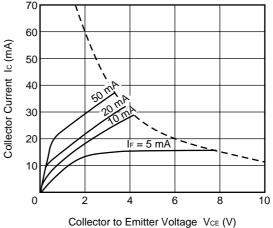


Data Sheet PN10251EJ04V0DS

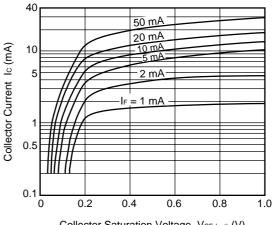


TRANSISTOR POWER DISSIPATION

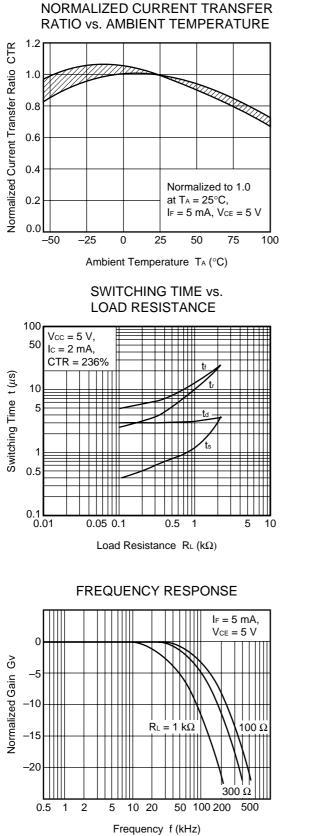
vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE



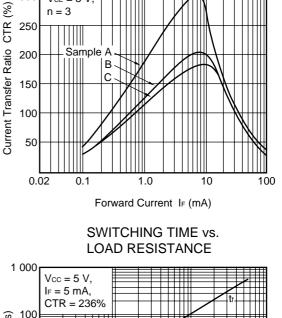
Collector Saturation Voltage VCE (sat) (V)





Data Sheet PN10251EJ04V0DS

Current Transfer Ratio CTR 200 150 100 50 0.02 0.1 1 000 Vcc = 5 V, I⊧ = 5 mA, 100

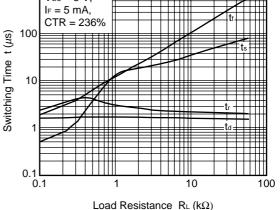


CURRENT TRANSFER RATIO vs.

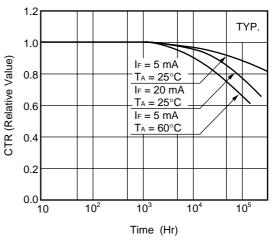
FORWARD CURRENT

300

 $V_{CE} = 5 V$ ,

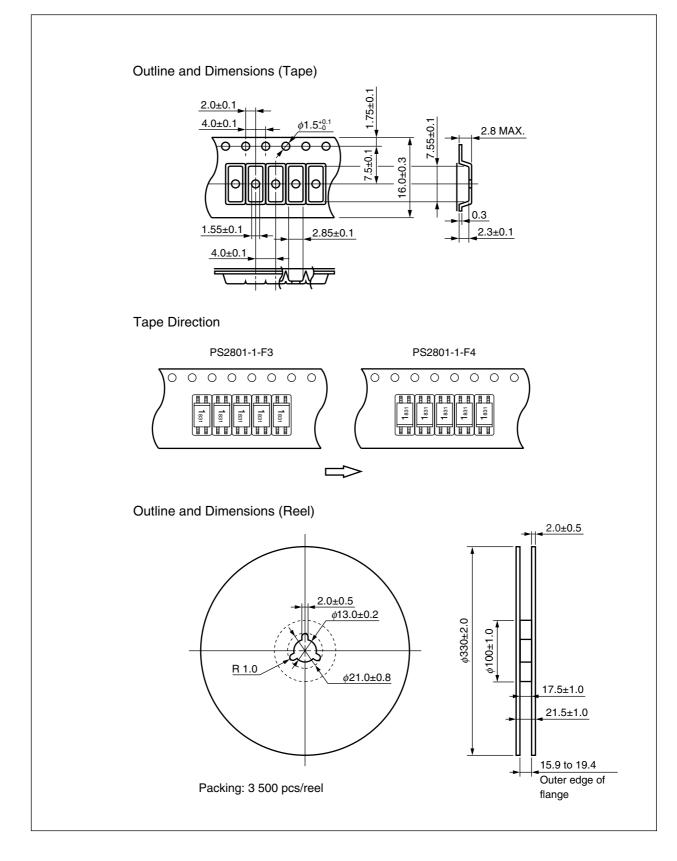


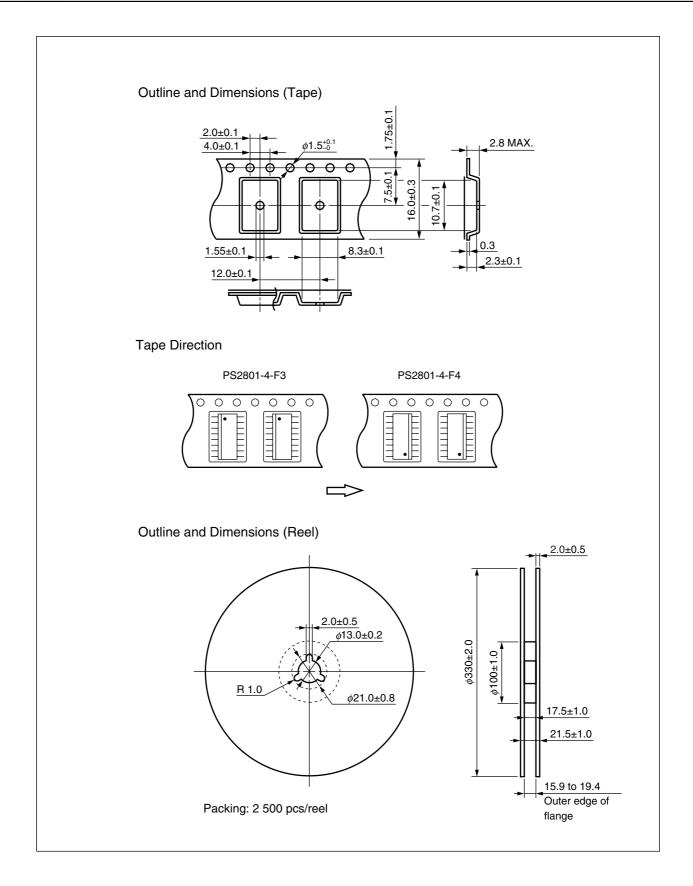




8

# TAPING SPECIFICATIONS (UNIT: mm)





# NOTES ON HANDLING

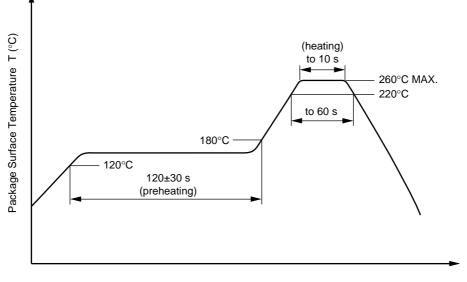
## 1. Recommended soldering conditions

## (1) Infrared reflow soldering

- · Peak reflow temperature
- · Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

### (3) Soldering by soldering iron

<ul> <li>Peak temperature (lead part temperature)</li> </ul>	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead.
- (b) Please be sure that the temperature of the package would not be heated over 100°C.

## (4) Cautions

## • Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

# 2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

## 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler

Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below  $I_F = 1$  mA.

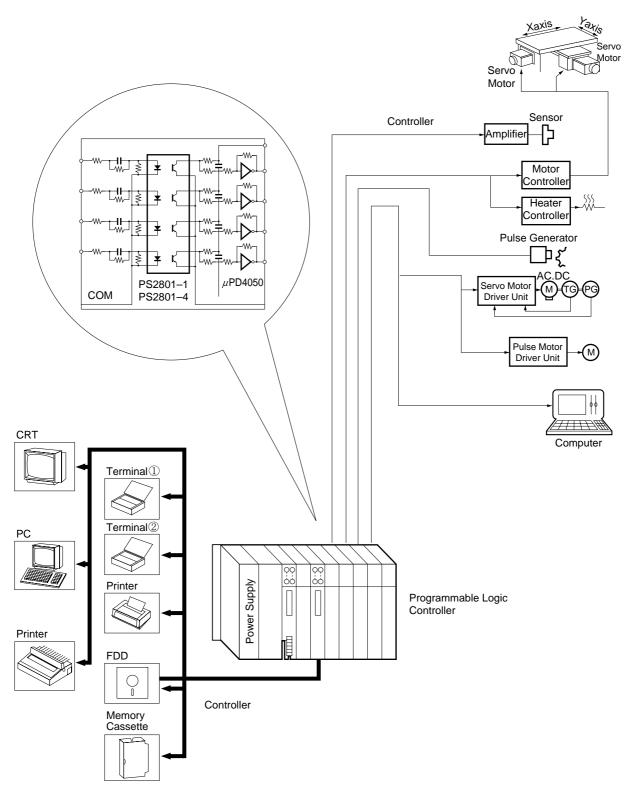
Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

# USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

# PROGRAMMABLE LOGIC CONTROLLERS EXAMPLE

Purpose: In-out interface



# <R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/110/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.5 \times U_{IORM}, P_d < 5 pC$	Uiorm Upr	705 1 058	V <sub>peak</sub> V <sub>peak</sub>
Test voltage (partial discharge test, procedure b for all devices) $U_{\text{pr}}$ = 1.875 $\times$ U_{IORM}, $P_{\text{d}}$ < 5 pC	Upr	1 322	V <sub>peak</sub>
Highest permissible overvoltage	Utr	6 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Clearance distance		>5.0	mm
Creepage distance		>5.0	mm
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303 Part 11))	CTI	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)		lll a	
Storage temperature range	Tstg	-55 to +150	°C
Operating temperature range	TA	-55 to +110	°C
Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^{\circ}\text{C}$	Ris MIN. Ris MIN.	10 <sup>12</sup> 10 <sup>11</sup>	Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve)			
Package temperature	Tsi	150	°C
Current (input current I <sub>F</sub> , Psi = 0) Power (output or total power dissipation) Isolation resistance	lsi Psi	300 500	mA mW
V <sub>IO</sub> = 500 V dc at $T_A$ = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

• The information in this document is current as of December, 2008. The information is subject to change without notice. For actual design-in, refer to the latest publications of NEC Electronics data sheets or data books, etc., for the most up-to-date specifications of NEC Electronics products. Not all products and/or types are available in every country. Please check with an NEC Electronics sales representative for availability and additional information.

- No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Electronics. NEC Electronics assumes no responsibility for any errors that may appear in this document.
- NEC Electronics does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from the use of NEC Electronics products listed in this document or any other liability arising from the use of such products. No license, express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Electronics or others.
- Descriptions of circuits, software and other related information in this document are provided for illustrative purposes in semiconductor product operation and application examples. The incorporation of these circuits, software and information in the design of a customer's equipment shall be done under the full responsibility of the customer. NEC Electronics assumes no responsibility for any losses incurred by customers or third parties arising from the use of these circuits, software and information.
- While NEC Electronics endeavors to enhance the quality, reliability and safety of NEC Electronics products, customers agree and acknowledge that the possibility of defects thereof cannot be eliminated entirely. To minimize risks of damage to property or injury (including death) to persons arising from defects in NEC Electronics products, customers must incorporate sufficient safety measures in their design, such as redundancy, fire-containment and anti-failure features.
- NEC Electronics products are classified into the following three quality grades: "Standard", "Special" and "Specific".

The "Specific" quality grade applies only to NEC Electronics products developed based on a customerdesignated "quality assurance program" for a specific application. The recommended applications of an NEC Electronics product depend on its quality grade, as indicated below. Customers must check the quality grade of each NEC Electronics product before using it in a particular application.

- "Standard": Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots.
- "Special": Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support).
- "Specific": Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems and medical equipment for life support, etc.

The quality grade of NEC Electronics products is "Standard" unless otherwise expressly specified in NEC Electronics data sheets or data books, etc. If customers wish to use NEC Electronics products in applications not intended by NEC Electronics, they must contact an NEC Electronics sales representative in advance to determine NEC Electronics' willingness to support a given application.

(Note)

- (1) "NEC Electronics" as used in this statement means NEC Electronics Corporation and also includes its majority-owned subsidiaries.
- (2) "NEC Electronics products" means any product developed or manufactured by or for NEC Electronics (as defined above).

M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	<ul> <li>Do not lick the product or in any way allow it to enter the mouth.</li> </ul>